

SOT920-1

plastic rectangular-DIL-bent-SIL (reverse bent) power package; 27 leads (row spacing 2.54 mm)

8 February 2016

Package information

1. Package summary

Terminal position code	Z (zig-zag)
Package type descriptive code	RDBS27P
Package type industry code	RDBS27P
Package style descriptive code	RDBS (right-angle DIL-bent-SIL)
Package style suffix code	P (power)
Package body material type	P (plastic)
Mounting method type	T (through-hole mount)
Issue date	27-10-2005

Table 1. Package summary

Symbol	Parameter		Min	Typ	Nom	Max	Unit
D	package length		28.8	-	29	29.2	mm
E	package width		15.5	-	15.7	15.9	mm
A ₂	package height		4.35	-	4.5	4.65	mm
n ₂	actual quantity of termination		-	-	27	-	



2. Package outline

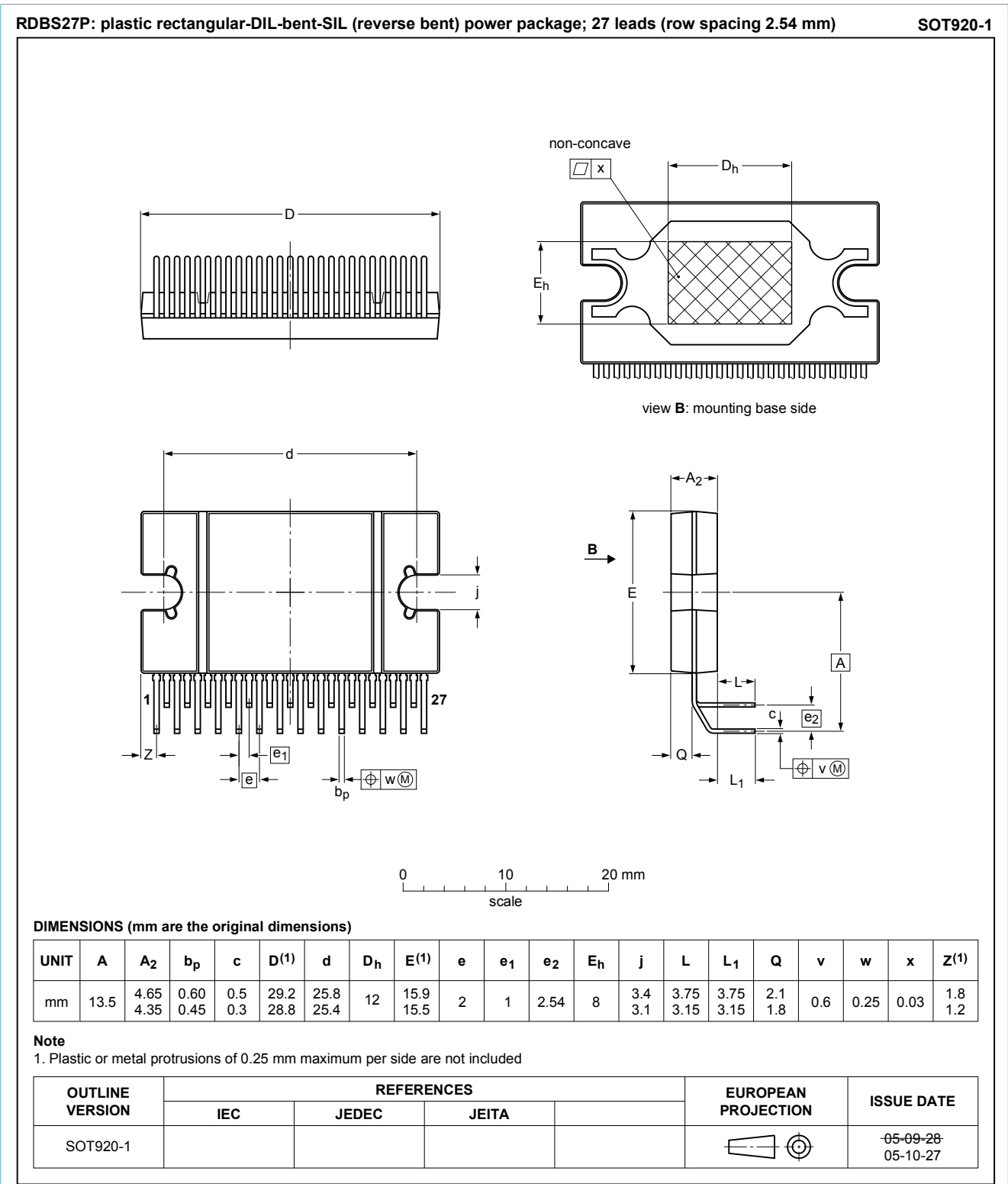


Fig. 1. Package outline RDBS27P (SOT920-1)

3. Legal information

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